

---

**DECLARATION - USA PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

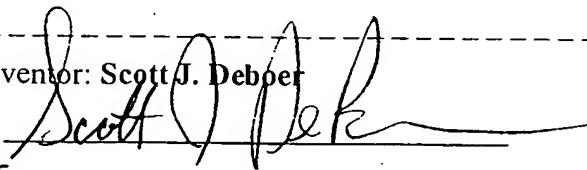
I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled METHOD AND STRUCTURE FOR REDUCING CONTACT ASPECT RATIOS; the specification of which is attached hereto;

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above;

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56;

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful, false statements may jeopardize the validity of the application or any patent issued thereon.

-----  
Full name of first inventor: Scott J. DeBoer

Inventor's signature 

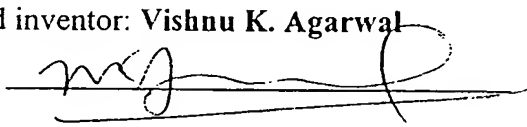
Date 6/9/99

Residence: 259 East Twin Willow, Boise, ID 83706

Citizenship: US

Post Office Address: same as above

Full name of second inventor: Vishnu K. Agarwal

Inventor's signature 

Date 6/9/99

Residence: 2382 East Red Cedar Lane, #A303, Boise, ID 83716

Citizenship: India

Post Office Address: same as above

---

Send Correspondence To:

KNOBBE, MARTENS, OLSON & BEAR, LLP

Customer No. 20,995

ASA-2706.DOC  
040699